

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ADAM SAFERNA	02/24/2016
DAWID SAFERNA	02/24/2016
RECEIVING PARTY DATA	
Name:	TECHPLAST SPOLKA Z O.O.
Street Address:	UL. RZYMSKA 4
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State/Country:	POLAND
Postal Code:	34-122
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15024744
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	KRT201
NAME OF SUBMITTER:	HORST M. KASPER
SIGNATURE:	/hmk/
DATE SIGNED:	03/28/2016
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

Adam SAFERNA, Wieprz 267, PL-34-122 WIEPRZ, POLAND and
Dawid SAFERNA, Wieprz 267, PL-34-122 WIEPRZ, POLAND

have made an invention in:

HIGH- PRESSURE COMPOSITE VESSEL AND THE METHOD OF MANUFACTURING HIGH-PRESSURE COMPOSITE VESSEL.

and have executed an application for Letters Patent of the United States of America based thereon

<> the _____ day of _____ 2016

<X> on even date herewith

<> and subsequently (*) officially identified as Serial Number _____ filed
on _____

AND WHEREAS, TECHPLAST SPÓŁKA Z O.O., residing and doing business at ul. Rzymaska 4, 34-122 WIEPRZ, POLAND is desirous of acquiring the entire right (including priority rights under any and all International Conventions), title and interest in and to the said invention in and throughout the United States of America, its Territories, and all countries foreign thereto, and in and to the said application for Letters Patent, and in and to any and all Letters Patent of the United States of America and countries foreign thereto, which have been or may be granted on said invention or any part thereof;

NOW THEREFORE, for one dollar and other good and valuable consideration, receipt of which is hereby acknowledged the said

Adam SAFERNA and Dawid SAFERNA

have agreed to and do hereby sell, assign and transfer unto the said TECHPLAST SPÓŁKA Z O.O. the entire right (including priority rights under any and all International Conventions), title and interest in and throughout the United States of America, its Territories and all countries foreign thereto in and to said invention, said application for Letters Patent, and any and all Letters Patent and extensions thereto, of the United States of America and countries foreign thereto which have been or may be granted on said invention or any part thereof, or on said application or any divisional, continuing, renewal, re-issue or other applications based on whole or in part thereon, or based upon said invention;

TO BE HELD AND ENJOYED by the said TECHPLAST SPÓŁKA Z O.O. its heirs, executors, administrators, successors, and assigns to the full ends of the terms for which said Letters Patent or any of them have been or be granted, as fully and entirely as the same would have been held and enjoyed by us had no sale and assignment of said interest been made; and we do hereby authorize and request the Commissioner of Patents of the United States of America to issue any and all Letters Patent of the United States of America which may be granted upon the said applications above referred to, or any of them, or upon said invention or any part thereof, to

TECHPLAST SPÓŁKA Z O.O. aforesaid; and we hereby agree for ourselves and for our heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any reissue, renewal, or other application for Letters Patent that may be deemed necessary by the assignee herein named, fully to secure to the said assignee TECHPLAST SPÓŁKA Z O.O. interest as aforesaid in and to said invention or any part thereof, and in and to several Letters Patent or any of them.

And we do hereby covenant for ourselves and our legal representatives and agree with TECHPLAST SPÓŁKA Z O.O. successors and assigns that we have granted no license to make, use or sell the said invention, that prior to the execution of this deed their right, title and interest in the said invention had not been encumbered, that we then had good right and title to sell and assign the same and that we have not executed and will not execute any instrument in conflict herewith.

(*) And, we hereby appoint Horst M. Kasper to insert in this instrument after execution identifying information and in particular the serial number and the filing date of said application for United States Letters Patent when officially notified thereof.

In Witness whereof, we have hereunto set our hands and affixed our seal this ____ day of _____ A.D. 2016

DATE _____



ADAM SAFERNA

WITNESS _____

DATE 24-02-2016

DATE _____



DAWID SAFERNA

WITNESS _____

DATE 24 02 2016

County of _____

State of _____

On this ____ day of _____ A.D. 2016 appeared the above named Adam Saferna and Dawid Saferna personally known to me, and known by me to be the one who executed the foregoing instrument, and acknowledge the same to be his free act and deed, before me.

Notary Public

%KRT201(23.Feb.2016(am/hl)

Assignment of Adam Saferna and Dawid Saferna

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